CAT5241

Quad Digital Potentiometer (POT) with 64 Taps and I²C Interface

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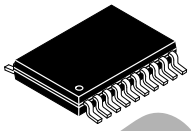
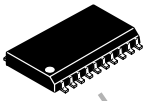


TSSOP−20
Y SUFFIX
CASE 948AQ



SOIC−20
W SUFFIX
CASE 751BJ

Description

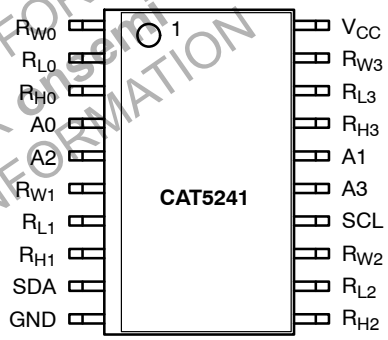
The CAT5241 is four Digital POTs integrated with control logic and 16 bytes of NVRAM memory. Each digital POT consists of a series of 63 resistive elements connected between two externally accessible end points. The tap points between each resistive element are connected to the wiper outputs with CMOS switches. A separate 6-bit control register (WCR) independently controls the wiper tap switches for each digital POT. Associated with each wiper control register are four 6-bit non-volatile memory data registers (DR) used for storing up to four wiper settings. Writing to the wiper control register or any of the non-volatile data registers is via a I²C serial bus. On power-up, the contents of the first data register (DR0) for each of the four potentiometers is automatically loaded into its respective wiper control register (WCR).

The CAT5241 can be used as a potentiometer or as a two terminal, variable resistor. It is intended for circuit level or system level adjustments in a wide variety of applications.

Features

- Four Linear-taper Digital Potentiometers
- 64 Resistor Taps per Potentiometer
- End to End Resistance 2.5 kΩ, 10 kΩ, 50 kΩ or 100 kΩ
- Potentiometer Control and Memory Access via I²C Interface
- Low Wiper Resistance, Typically 80 Ω
- Nonvolatile Memory Storage for up to Four Wiper Settings for Each Potentiometer
- Automatic Recall of Saved Wiper Settings at Power Up
- 2.5 to 6.0 Volt Operation
- Standby Current less than 1 μA
- 1,000,000 Nonvolatile WRITE Cycles
- 100 Year Nonvolatile Memory Data Retention
- 20-lead SOIC and TSSOP Packages
- Industrial Temperature Range
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

PIN CONNECTIONS



SOIC−20 (W)
TSSOP−20 (Y)
(Top View)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 14 of this data sheet.

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CAT5241/D

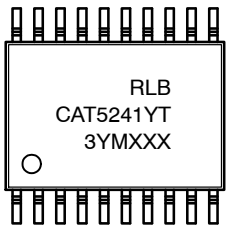
MARKING DIAGRAMS

(SOIC−20)



L = Assembly Location
3 = Lead Finish − Matte−Tin
B = Product Revision (Fixed as “B”)
CAT5241W = Device Code
T = Temperature Range (I = Industrial)
− = Dash
RR = Resistance
25 = 2.5 KΩ
10 = 10 KΩ
50 = 50 KΩ
00 = 100 KΩ
Y = Production Year (Last Digit)
M = Production Month (1−9, O, N, D)
XXXX = Last Four Digits of Assembly Lot Number

(TSSOP−20)



R = Resistance
1 = 2.5 KΩ
2 = 10 KΩ
4 = 50 KΩ
5 = 100 KΩ
L = Assembly Location
B = Product Revision (Fixed as “B”)
CAT5241Y = Device Code
T = Temperature Range (I = Industrial)
3 = Lead Finish − Matte−Tin
Y = Production Year (Last Digit)
M = Production Month (1−9, O, N, D)
XXX = Last Three Digits of Assembly Lot Number

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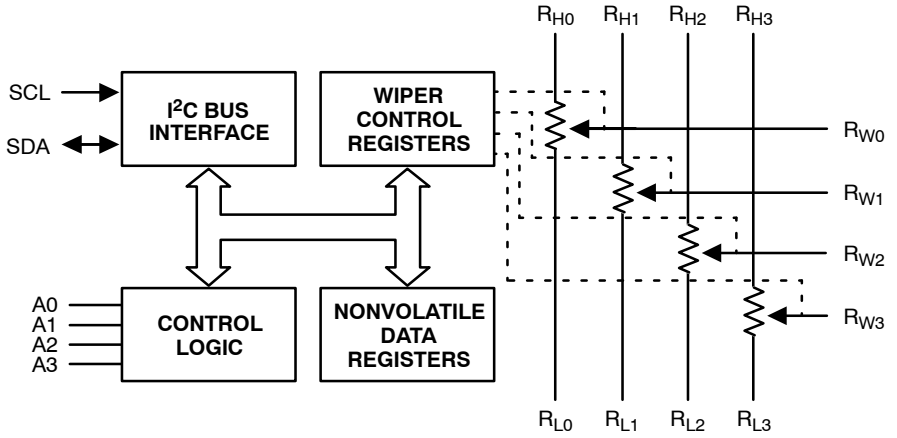

Figure 1. Functional Diagram

Table 1. PIN DESCRIPTION

Pin (SOIC)	Name	Function
1	R_{W0}	Wiper Terminal for Potentiometer 0
2	R_{L0}	Low Reference Terminal for Potentiometer 0
3	R_{H0}	High Reference Terminal for Potentiometer 0
4	A0	Device Address, LSB
5	A2	Device Address
6	R_{W1}	Wiper Terminal for Potentiometer 1
7	R_{L1}	Low Reference Terminal for Potentiometer 1
8	R_{H1}	High Reference Terminal for Potentiometer 1
9	SDA	Serial Data Input/Output
10	GND	Ground
11	R_{H2}	High Reference Terminal for Potentiometer 2
12	R_{L2}	Low Reference Terminal for Potentiometer 2
13	R_{W2}	Wiper Terminal for Potentiometer 2
14	SCL	Bus Serial Clock
15	A3	Device Address
16	A1	Device Address
17	R_{H3}	High Reference Terminal for Potentiometer 3
18	R_{L3}	Low Reference Terminal for Potentiometer 3
19	R_{W3}	Wiper Terminal for Potentiometer 3
20	V_{CC}	Supply Voltage

Pin Descriptions

SCL: Serial Clock

The CAT5241 serial clock input pin is used to clock all data transfers into or out of the device.

SDA: Serial Data

The CAT5241 bidirectional serial data pin is used to transfer data into and out of the device. The SDA pin is an open drain output and can be wire-OR'd with the other open drain or open collector outputs.

A0, A1, A2, A3: Device Address Inputs

These inputs set the device address when addressing multiple devices. A total of sixteen devices can be addressed on a single bus. A match in the slave address must be made with the address input in order to initiate communication with the CAT5241.

R_H, R_L: Resistor End Points

The four sets of R_H and R_L pins are equivalent to the terminal connections on a mechanical potentiometer.

R_W: Wiper

The four R_W pins are equivalent to the wiper terminal of a mechanical potentiometer.

Device Operation

The CAT5241 is four resistor arrays integrated with I^2C serial interface logic, four 6-bit wiper control registers and sixteen 6-bit, non-volatile memory data registers. Each resistor array contains 63 separate resistive elements connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer (R_H and R_L). R_H and R_L are symmetrical and may be interchanged. The tap positions between and at the ends of the series resistors are connected to the output wiper terminals (R_W) by a CMOS transistor switch. Only one tap point for each potentiometer is connected to its wiper terminal at a time and is determined by the value of the wiper control register. Data can be read or written to the wiper control registers or the non-volatile memory data registers via the I^2C bus. Additional instructions allow data to be transferred between the wiper control registers and each respective potentiometer's non-volatile data registers. Also, the device can be instructed to operate in an "increment/decrement" mode.

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Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Ratings	Units
Temperature Under Bias	−55 to +125	°C
Storage Temperature Range	−65 to +150	°C
Voltage on any Pin with Respect to V_{SS} (Notes 1, 2)	−2.0 to +V_{CC} +2.0	V
V_{CC} with Respect to Ground	−2.0 to +7.0	V
Package Power Dissipation Capability (T_A = 25°C)	1.0	W
Lead Soldering Temperature (10 s)	300	°C
Wiper Current	±12	mA

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The minimum DC input voltage is −0.5 V. During transitions, inputs may undershoot to −2.0 V for periods of less than 20 ns. Maximum DC voltage on output pins is V_{CC} + 0.5 V, which may overshoot to V_{CC} + 2.0 V for periods of less than 20 ns.
2. Latch-up protection is provided for stresses up to 100 mA on address and data pins from −1 V to V_{CC} + 1 V.

Table 3. RECOMMENDED OPERATING CONDITIONS

Parameter	Ratings	Units
V_{CC}	+2.5 to +6.0	V
Operating Ambient Temperature (Industrial)	−40 to +85	°C

Table 4. POTENTIOMETER CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
R_{POT}	Potentiometer Resistance (−00)			100		kΩ
R_{POT}	Potentiometer Resistance (−50)			50		kΩ
R_{POT}	Potentiometer Resistance (−10)			10		kΩ
R_{POT}	Potentiometer Resistance (−25)			2.5		kΩ
	Potentiometer Resistance Tolerance				±20	%
	R_{POT} Matching				1	%
	Power Rating	25°C, each pot			50	mW
I_W	Wiper Current				±6	mA
R_W	Wiper Resistance	I_W = ±3 mA @ V_{CC} = 3 V			300	Ω
R_W	Wiper Resistance	I_W = ±3 mA @ V_{CC} = 5 V		80	150	Ω
V_{TERM}	Voltage on any R_H or R_L Pin	V_{SS} = 0 V	GND		V_{CC}	
V_N	Noise	(Note 3)		TBD		nV/√Hz
	Resolution			1.6		%
	Absolute Linearity (Note 4)	$R_{W(n)(actual)} - R_{(n)(expected)}$ (Note 7)			±1	LSB (Note 6)
	Relative Linearity (Note 5)	$R_{W(n+1)} - [R_{W(n)+LSB}]$ (Note 7)			±0.2	LSB (Note 6)
TC_{RPOT}	Temperature Coefficient of R_{POT}	(Note 3)		±300		ppm/°C
TC_{RATIO}	Ratiometric Temp. Coefficient	(Note 3)			20	ppm/°C
$C_H/C_L/C_W$	Potentiometer Capacitances	(Note 3)		10/10/25		pF
fc	Frequency Response	R_{POT} = 50 kΩ (Note 3)		0.4		MHz

3. This parameter is tested initially and after a design or process change that affects the parameter.
4. Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.
5. Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
6. LSB = R_{TOT} / 63 or (R_H − R_L) / 63, single pot
7. n = 0, 1, 2, ..., 63

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Table 5. D.C. OPERATING CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
I_{CC}	Power Supply Current	f_{SCL} = 400 kHz			1	mA
I_{SB}	Standby Current (V_{CC} = 5.0 V)	V_{IN} = GND or V_{CC}; SDA = GND; RWX = GND (Note 8)			1	μA
I_{LI}	Input Leakage Current	V_{IN} = GND to V_{CC}			10	μA
I_{LO}	Output Leakage Current	V_{OUT} = GND to V_{CC}			10	μA
V_{IL}	Input Low Voltage		–1		V_{CC} x 0.3	V
V_{IH}	Input High Voltage		V_{CC} x 0.7		V_{CC} + 1.0	V
V_{OL1}	Output Low Voltage (V_{CC} = 3.0 V)	I_{OL} = 3 mA			0.4	V

8. All four wiper terminals RW0, RW1, RW2, and RW3 are tied to ground.

Table 6. CAPACITANCE (Note 9) (T_A = 25°C, f = 1.0 MHz, V_{CC} = +5.0 V)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$C_{I/O}$	Input/Output Capacitance (SDA)	$V_{I/O}$ = 0 V			8	pF
C_{IN}	Input Capacitance (A0, A1, A2, A3, SCL)	V_{IN} = 0 V			6	pF

Table 7. A.C. CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Min	Typ	Max	Units
f_{SCL}	Clock Frequency			400	kHz
T_I (Note 9)	Noise Suppression Time Constant at SCL, SDA Inputs			50	ns
t_{AA}	SLC Low to SDA Data Out and ACK Out			0.9	μs
t_{BUF} (Note 9)	Time the Bus Must Be Free Before a New Transmission Can Start	1.2			μs
$t_{HD:STA}$	Start Condition Hold Time	0.6			μs
t_{LOW}	Clock Low Period	1.2			μs
t_{HIGH}	Clock High Period	0.6			μs
$t_{SU:STA}$	Start Condition Setup Time (For a Repeated Start Condition)	0.6			μs
$t_{HD:DAT}$	Data in Hold Time	0			ns
$t_{SU:DAT}$	Data in Setup Time	100			ns
t_R (Note 9)	SDA and SCL Rise Time			0.3	μs
t_F (Note 9)	SDA and SCL Fall Time			300	ns
$t_{SU:STO}$	Stop Condition Setup Time	0.6			μs
t_{DH}	Data Out Hold Time	50			ns

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Table 8. POWER UP TIMING (Note 9) (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Min	Typ	Max	Units
t_{PUR}	Power-up to Read Operation			1	ms
t_{PUW}	Power-up to Write Operation			1	ms

9. This parameter is tested initially and after a design or process change that affects the parameter.

Table 9. WRITE CYCLE LIMITS (Note 10) (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Min	Typ	Max	Units
t_{WR}	Write Cycle Time			5	ms

10. The write cycle is the time from a valid stop condition of a write sequence to the end of the internal program/erase cycle. During the write cycle, the bus interface circuits are disabled, SDA is allowed to remain high, and the device does not respond to its slave address.

Table 10. RELIABILITY CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

Symbol	Parameter	Reference Test Method	Min	Typ	Max	Units
N_{END} (Note 11)	Endurance	MIL−STD−883, Test Method 1033	1,000,000			Cycles/Byte
T_{DR} (Note 11)	Data Retention	MIL−STD−883, Test Method 1008	100			Years
V_{ZAP} (Note 11)	ESD Susceptibility	MIL−STD−883, Test Method 3015	2000			Volts
I_{LTH} (Notes 11, 12)	Latch-Up	JEDEC Standard 17	100			mA

11. This parameter is tested initially and after a design or process change that affects the parameter.
12. t_{PUR} and t_{PUW} are the delays required from the time V_{CC} is stable until the specified operation can be initiated.

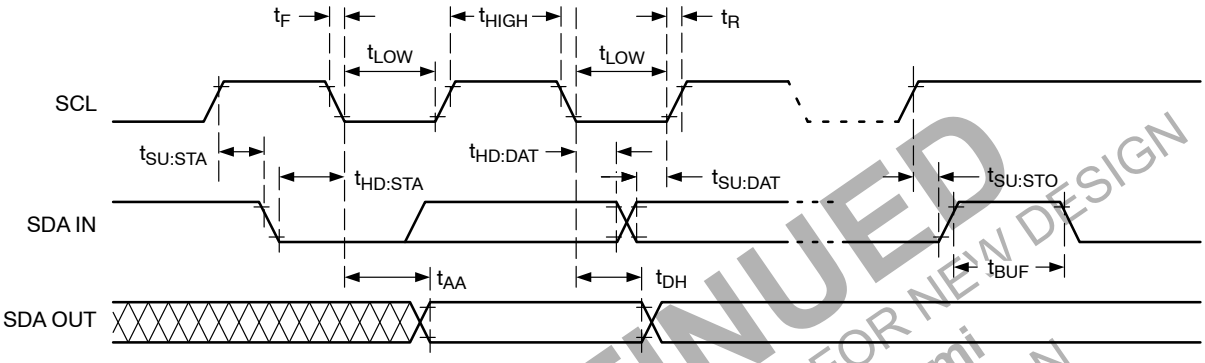

Figure 2. Bus Timing

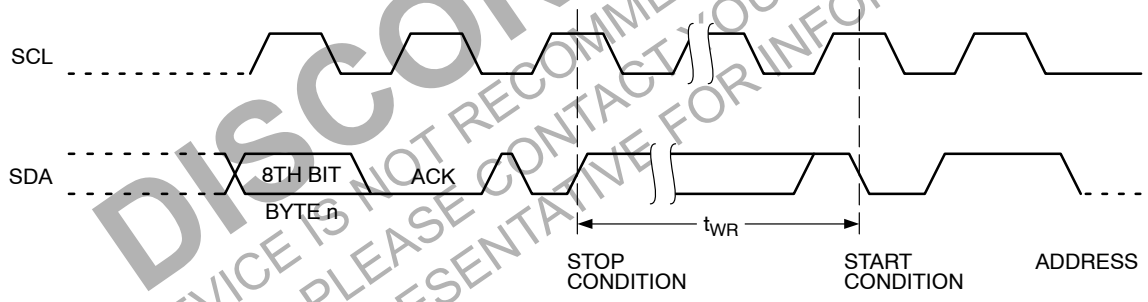

Figure 3. Write Cycle Timing

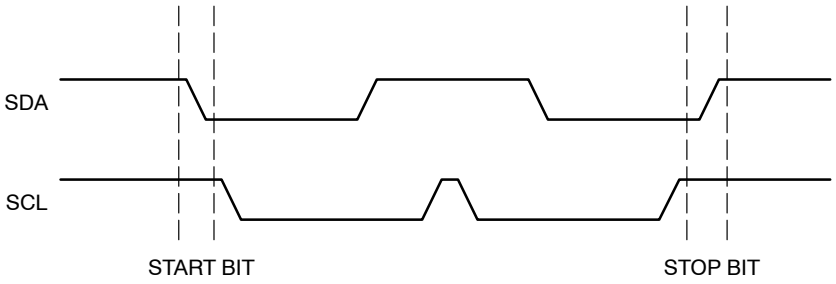

Figure 4. Start/Stop Timing

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Serial Bus Protocol

The following defines the features of the I^2C bus protocol:

1. Data transfer may be initiated only when the bus is not busy.
2. During a data transfer, the data line must remain stable whenever the clock line is high. Any changes in the data line while the clock is high will be interpreted as a START or STOP condition.

The device controlling the transfer is a master, typically a processor or controller, and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the CAT5241 will be considered a slave device in all applications.

START Condition

The START Condition precedes all commands to the device, and is defined as a HIGH to LOW transition of SDA when SCL is HIGH. The CAT5241 monitors the SDA and SCL lines and will not respond until this condition is met.

STOP Condition

A LOW to HIGH transition of SDA when SCL is HIGH determines the STOP condition. All operations must end with a STOP condition.

Device Addressing

The bus Master begins a transmission by sending a START condition. The Master then sends the address of the particular slave device it is requesting. The four most significant bits of the 8-bit slave address are fixed as 0101 for the CAT5241 (see Figure 6). The next four significant bits (A3, A2, A1, A0) are the device address bits and define which device the Master is accessing. Up to sixteen devices may be individually addressed by the system. Typically, +5 V and ground are hard-wired to these pins to establish the device's address.

After the Master sends a START condition and the slave address byte, the CAT5241 monitors the bus and responds with an acknowledge (on the SDA line) when its address matches the transmitted slave address.

Acknowledge

After a successful data transfer, each receiving device is required to generate an acknowledge. The Acknowledging device pulls down the SDA line during the ninth clock cycle, signaling that it received the 8 bits of data.

The CAT5241 responds with an acknowledge after receiving a START condition and its slave address. If the device has been selected along with a write operation, it responds with an acknowledge after receiving each 8-bit byte.

When the CAT5241 is in a READ mode it transmits 8 bits of data, releases the SDA line, and monitors the line for an acknowledge. Once it receives this acknowledge, the CAT5241 will continue to transmit data. If no acknowledge is sent by the Master, the device terminates data transmission and waits for a STOP condition.

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Figure 5. Acknowledge Timing

Write Operation

In the Write mode, the Master device sends the START condition and the slave address information to the Slave device. After the Slave generates an acknowledge, the Master sends the instruction byte that defines the requested operation of CAT5241. The instruction byte consist of a four-bit opcode followed by two register selection bits and two pot selection bits. After receiving another acknowledge from the Slave, the Master device transmits the data to be written into the selected register. The CAT5241 acknowledges once more and the Master generates the STOP condition, at which time if a non-volatile data register is being selected, the device begins an internal programming cycle to non-volatile memory. While this internal cycle is in progress, the device will not respond to any request from the Master device.

Acknowledge Polling

The disabling of the inputs can be used to take advantage of the typical write cycle time. Once the stop condition is issued to indicate the end of the host's write operation, the CAT5241 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the slave address. If the CAT5241 is still busy with the write operation, no ACK will be returned. If the CAT5241 has completed the write operation, an ACK will be returned and the host can then proceed with the next instruction operation.

CAT5241	0	1	0	1	A3	A2	A1	A0

* A0, A1, A2 and A3 correspond to pin A0, A1, A2 and A3 of the device.
** A0, A1, A2 and A3 must compare to its corresponding hard wired input pins.

Figure 6. Slave Address Bits

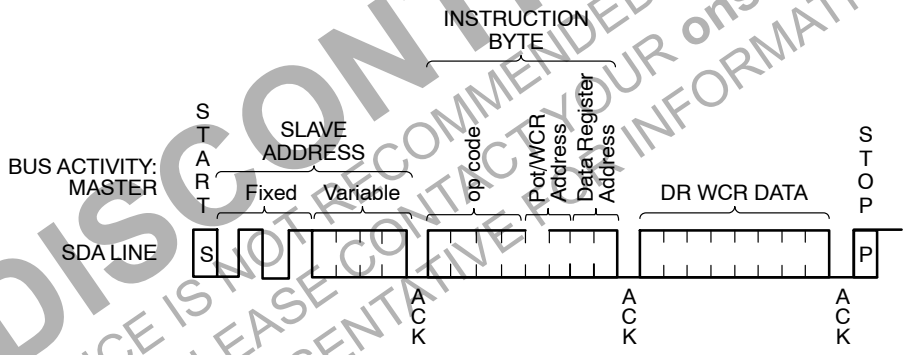

Figure 7. Write Timing

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Instructions and Register Description

Slave Address Byte

The first byte sent to the CAT5241 from the master/ processor is called the Slave Address Byte. The most significant four bits of the slave address are a device type identifier. These bits for the CAT5241 are fixed at 0101[B] (refer to Figure 8).

The next four bits, A3 – A0, are the internal slave address and must match the physical device address which is defined by the state of the A3 – A0 input pins for the CAT5241 to successfully continue the command sequence. Only the device which slave address matches the incoming device address sent by the master executes the instruction. The A3 – A0 inputs can be actively driven by CMOS input signals or tied to V_{CC} or V_{SS}.

Instruction Byte

The next byte sent to the CAT5241 contains the instruction and register pointer information. The four most significant bits used provide the instruction opcode I [3:0]. The P1 and P0 bits point to one of four Wiper Control Registers. The least two significant bits, R1 and R0, point to one of the four data registers of each associated potentiometer. The format is shown in Figure 9.

Table 11. DATA REGISTER SELECTION

Data Register Selected	R1	R0
DR0	0	0
DR1	0	1
DR2	1	0
DR3	1	1

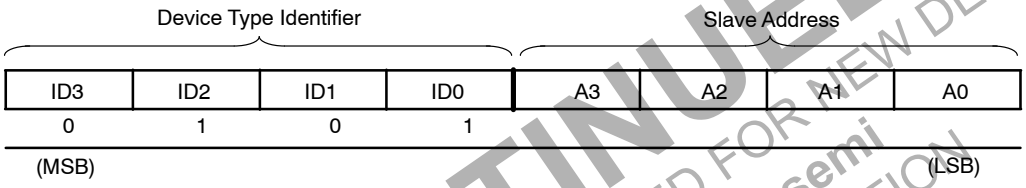

Figure 8. Identification Byte Format

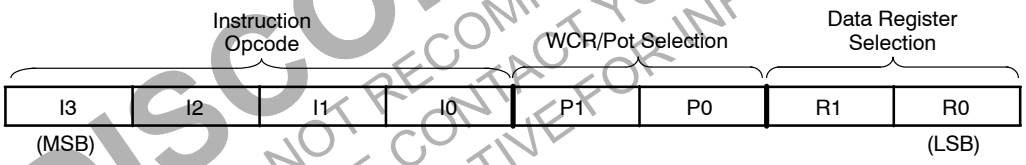

Figure 9. Instruction Byte Format

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Wiper Control and Data Registers

Wiper Control Register (WCR)

The CAT5241 contains four 6-bit Wiper Control Registers, one for each potentiometer. The Wiper Control Register output is decoded to select one of 64 switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written by the host via Write Wiper Control Register instruction; it may be written by transferring the contents of one of four associated Data Registers via the XFR Data Register instruction, it can be modified one step at a time by the Increment/decrement instruction (see Instruction section for more details). Finally, it is loaded with the content of its data register zero (DR0) upon power-up.

The Wiper Control Register is a volatile register that loses its contents when the CAT5241 is powered-down. Although the register is automatically loaded with the value in DR0 upon power-up, this may be different from the value present at power-down.

Data Registers (DR)

Each potentiometer has four 6-bit non-volatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four Data Registers and the associated Wiper Control Register. Any data changes in one of the Data Registers is a non-volatile operation and will take a maximum of 5 ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as standard memory locations for system parameters or user preference data.

Instructions

Four of the nine instructions are three bytes in length. These instructions are:

- **Read Wiper Control Register –** read the current wiper position of the selected potentiometer in the WCR
- **Write Wiper Control Register –** change current wiper position in the WCR of the selected potentiometer
- **Read Data Register –** read the contents of the selected Data Register
- **Write Data Register –** write a new value to the selected Data Register.

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Table 12. INSTRUCTION SET (**Note:** 1/0 = data is one or zero)

Instruction	Instruction Set								Operations
	I3	I2	I1	I0	WCR1/P1	WCR0/P0	R1	R0	
Read Wiper Control Register	1	0	0	1	1/0	1/0	0	0	Read the contents of the Wiper Control Register pointed to by P1–P0
Write Wiper Control Register	1	0	1	0	1/0	1/0	0	0	Write new value to the Wiper Control Register pointed to by P1–P0
Read Data Register	1	0	1	1	1/0	1/0	1/0	1/0	Read the contents of the Data Register pointed to by P1–P0 and R1–R0
Write Data Register	1	1	0	0	1/0	1/0	1/0	1/0	Write new value to the Data Register pointed to by P1–P0 and R1–R0
XFR Data Register to Wiper Control Register	1	1	0	1	1/0	1/0	1/0	1/0	Transfer the contents of the Data Register pointed to by P1–P0 and R1–R0 to its associated Wiper Control Register
XFR Wiper Control Register to Data Register	1	1	1	0	1/0	1/0	1/0	1/0	Transfer the contents of the Wiper Control Register pointed to by P1–P0 to the Data Register pointed to by R1–R0
Global XFR Data Registers to Wiper Control Registers	0	0	0	1	0	0	1/0	1/0	Transfer the contents of the Data Registers pointed to by R1–R0 of all four pots to their respective Wiper Control Registers
Global XFR Wiper Control Registers to Data Register	1	0	0	0	0	0	1/0	1/0	Transfer the contents of both Wiper Control Registers to their respective data Registers pointed to by R1–R0 of all four pots
Increment/Decrement Wiper Control Register	0	0	1	0	1/0	1/0	0	0	Enable Increment/decrement of the Control Latch pointed to by P1–P0

The basic sequence of the three byte instructions is illustrated in Figure 11. These three-byte instructions exchange data between the WCR and one of the Data Registers. The WCR controls the position of the wiper. The response of the wiper to this action will be delayed by t_{WRL}. A transfer from the WCR (current wiper position), to a Data Register is a write to non-volatile memory and takes a maximum of t_{WR} to complete. The transfer can occur between one of the four potentiometers and one of its associated registers; or the transfer can occur between all potentiometers and one associated register.

Four instructions require a two-byte sequence to complete, as illustrated in Figure 10. These instructions transfer data between the host/processor and the CAT5241; either between the host and one of the data registers or directly between the host and the Wiper Control Register. These instructions are:

- **XFR Data Register to Wiper Control Register**
  This transfers the contents of one specified Data Register to the associated Wiper Control Register.
- **XFR Wiper Control Register to Data Register**
  This transfers the contents of the specified Wiper Control Register to the specified associated Data Register.
- **Global XFR Data Register to Wiper Control Register**
  This transfers the contents of all specified Data Registers to the associated Wiper Control Registers.
- **Global XFR Wiper Counter Register to Data Register**
  This transfers the contents of all Wiper Control Registers to the specified associated Data Registers.

Increment/Decrement Command

The final command is Increment/Decrement (Figures 6 and 12). The Increment/Decrement command is different from the other commands. Once the command is issued and the CAT5241 has responded with an acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby providing a fine tuning capability to the host. For each SCL clock pulse (t_{HIGH}) while SDA is HIGH, the selected wiper will move one resistor segment towards the R_H terminal. Similarly, for each SCL clock pulse while SDA is LOW, the selected wiper will move one resistor segment towards the R_L terminal.

See Instructions format for more detail.

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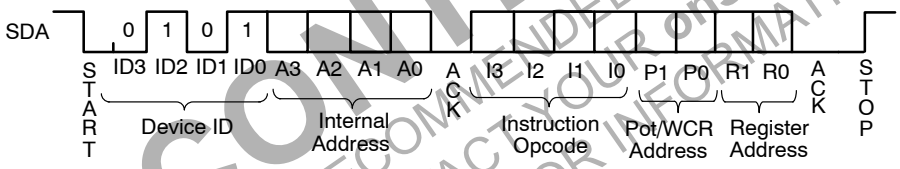

Figure 10. Two-Byte Instruction Sequence

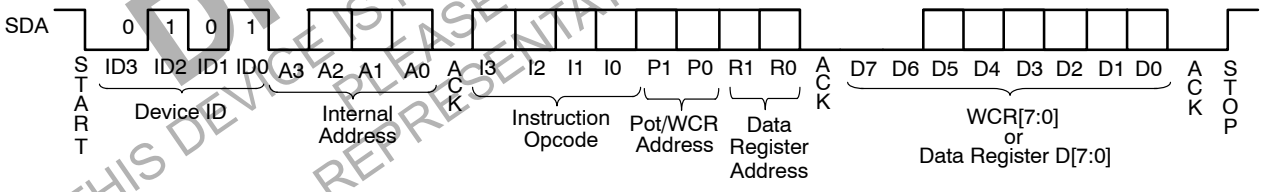

Figure 11. Three-Byte Instruction Sequence

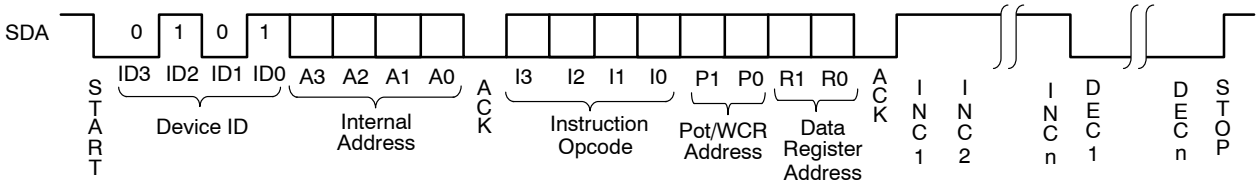

Figure 12. Increment/Decrement Instruction Sequence

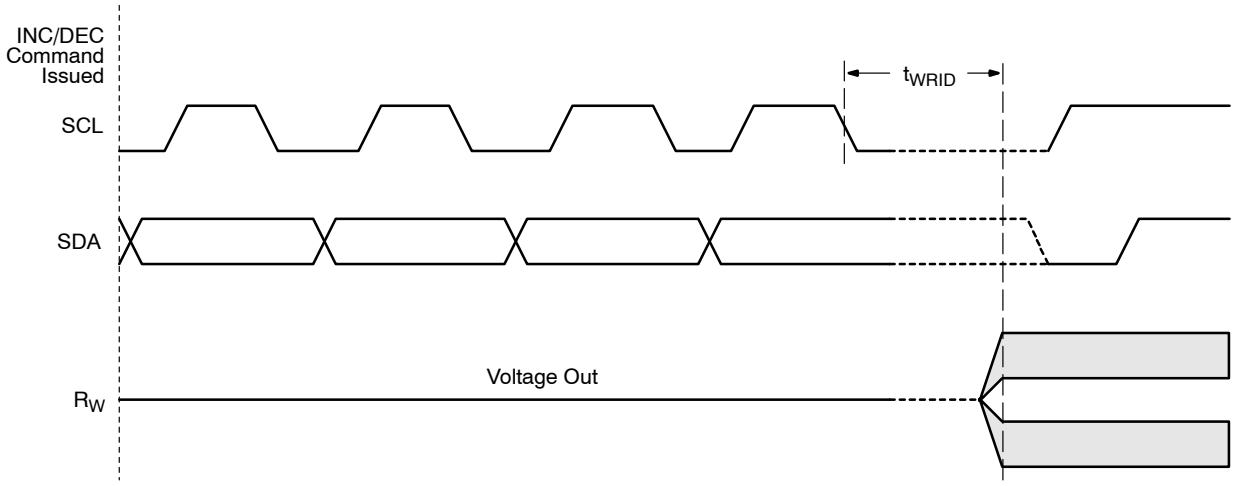

Figure 13. Increment/Decrement Timing Limits

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Instruction Format

Table 13. READ WIPER CONTROL REGISTER (WCR)

S T A R T	DEVICE ADDRESSES								A C K	INSTRUCTION								A C K	DATA								A C K	S T O P
	0	1	0	1	A3	A2	A1	A0		1	0	0	1	P1	P0	0	0		7	6	5	4	3	2	1	0		

Table 14. WRITE WIPER CONTROL REGISTER (WCR)

S T A R T	DEVICE ADDRESSES								A C K	INSTRUCTION								A C K	DATA								A C K	S T O P
	0	1	0	1	A3	A2	A1	A0		1	0	1	0	P1	P0	0	0		7	6	5	4	3	2	1	0		

Table 15. READ DATA REGISTER (DR)

S T A R T	DEVICE ADDRESSES								A C K	INSTRUCTION								A C K	DATA								A C K	S T O P
	0	1	0	1	A3	A2	A1	A0		1	0	1	1	P1	P0	R1	R0		7	6	5	4	3	2	1	0		

Table 16. WRITE DATA REGISTER (DR)

S T A R T	DEVICE ADDRESSES								A C K	INSTRUCTION								A C K	DATA								A C K	S T O P
	0	1	0	1	A3	A2	A1	A0		1	1	0	0	P1	P0	R1	R0		7	6	5	4	3	2	1	0		

Instruction Format (continued)

Table 17. GLOBAL TRANSFER DATA REGISTER (DR) TO WIPER CONTROL REGISTER (WCR)

START	DEVICE ADDRESSES								ACK	INSTRUCTION								ACK	STOP
	0	1	0	1	A3	A2	A1	A0		0	0	0	1	0	0	R1	R0		

Table 18. GLOBAL TRANSFER WIPER CONTROL REGISTER (WCR) TO DATA REGISTER (DR)

START	DEVICE ADDRESSES								ACK	INSTRUCTION								ACK	STOP
	0	1	0	1	A3	A2	A1	A0		1	0	0	0	0	0	R1	R0		

Table 19. TRANSFER WIPER CONTROL REGISTER (WCR) TO DATA REGISTER (DR)

START	DEVICE ADDRESSES								ACK	INSTRUCTION								ACK	STOP
	0	1	0	1	A3	A2	A1	A0		1	1	1	0	P1	P0	R1	R0		

Table 20. TRANSFER DATA REGISTER (DR) TO WIPER CONTROL REGISTER (WCR)

START	DEVICE ADDRESSES								ACK	INSTRUCTION								ACK	STOP
	0	1	0	1	A3	A2	A1	A0		1	1	0	1	P1	P0	R1	R0		

Table 21. INCREMENT (I)/DECREMENT (D) WIPER CONTROL REGISTER (WCR)

START	DEVICE ADDRESSES								ACK	INSTRUCTION								ACK	DATA					STOP
	0	1	0	1	A3	A2	A1	A0		0	0	1	0	P1	P0	0	0		I/D	I/D	. . .	I/D	I/D	

NOTE: Any write or transfer to the Non-volatile Data Registers is followed by a high voltage cycle after a STOP has been issued.

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Table 22. ORDERING INFORMATION

Orderable Part Number	Resistance (kΩ)	Lead Finish	Package	Shipping†
CAT5241WI−25−T1	2.5	Matte−Tin	SOIC (Pb−Free)	1000 / Tape & Reel
CAT5241WI−10−T1	10			
CAT5241WI−50−T1	50			
CAT5241WI−00−T1	100			
CAT5241YI−25−T2	2.5		TSSOP (Pb−Free)	2000 / Tape & Reel
CAT5241YI−10−T2	10			
CAT5241YI−50−T2	50			
CAT5241YI−00−T2	100			
CAT5241WI25	2.5		SOIC (Pb−Free)	36 Units / Tube
CAT5241WI10	10			
CAT5241WI50	50			
CAT5241WI00	100			
CAT5241YI25	2.5		TSSOP (Pb−Free)	74 Units / Tube
CAT5241YI10	10			
CAT5241YI50	50			
CAT5241YI00	100			

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

13. For detailed information and a breakdown of device nomenclature and numbering systems, please see the ON Semiconductor Device Nomenclature document, TND310/D, available at www.onsemi.com.
14. All packages are RoHS-compliant (Lead-free, Halogen-free).
15. The standard lead finish is Matte-Tin.
16. For additional package and temperature options, please contact your nearest ON Semiconductor Sales office.

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SOIC−20, 300 mils
CASE 751BJ
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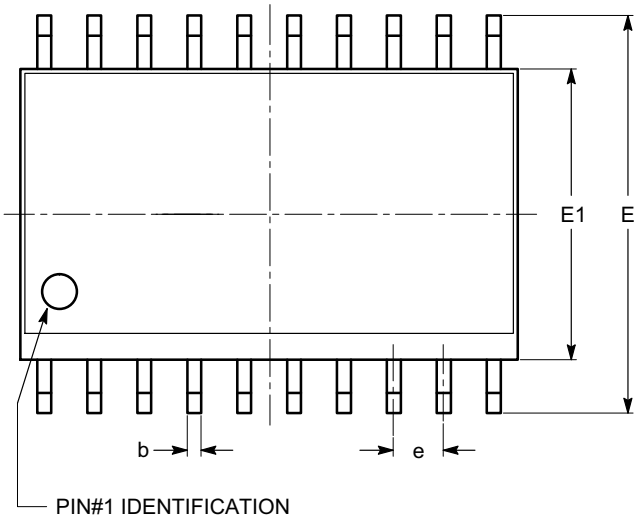
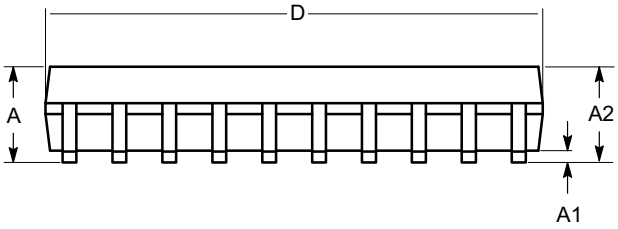
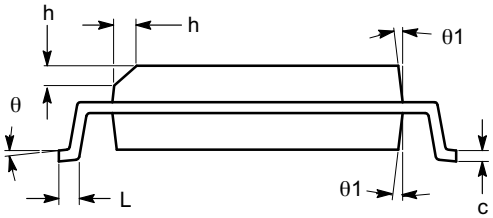


TOP VIEW

SYMBOL	MIN	NOM	MAX
A	2.36	2.49	2.64
A1	0.10		0.30
A2	2.05		2.55
b	0.31	0.41	0.51
c	0.20	0.27	0.33
D	12.60	12.80	13.00
E	10.01	10.30	10.64
E1	7.40	7.50	7.60
e		1.27 BSC	
h	0.25		0.75
L	0.40	0.81	1.27
θ	0°		8°
θ1	5°		15°



SIDE VIEW



END VIEW

Notes:
(1) All dimensions are in millimeters. Angles in degrees.
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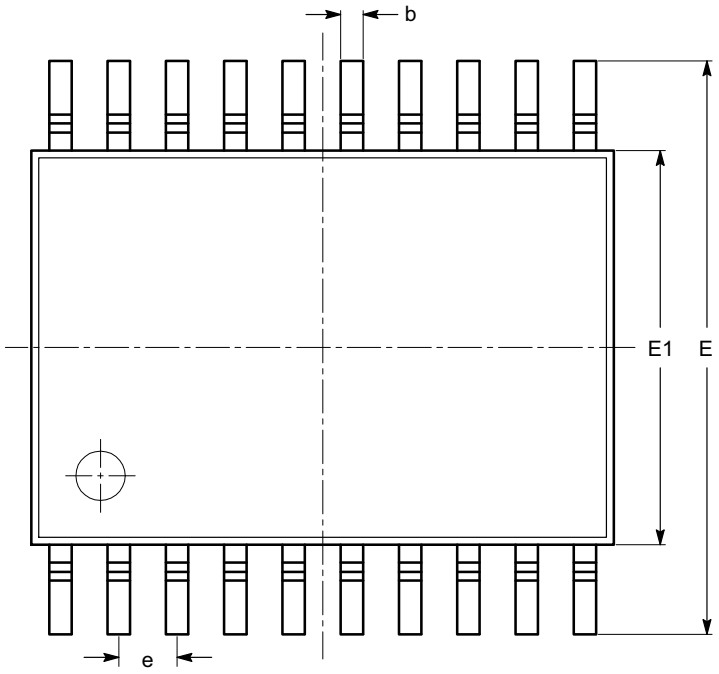
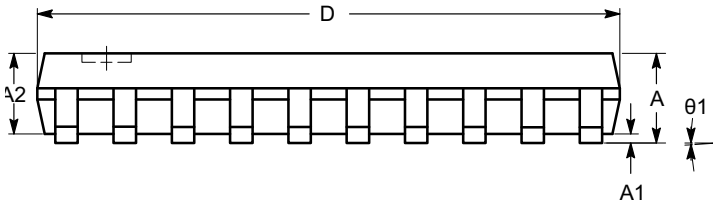
TSSOP20, 4.4x6.5
CASE 948AQ
ISSUE A

DATE 19 MAR 2009

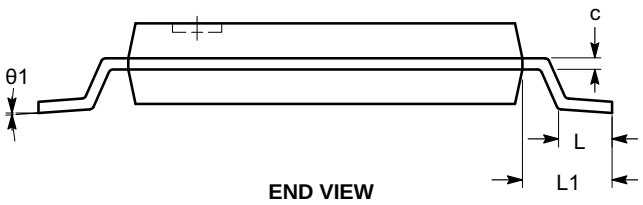


TOP VIEW

SYMBOL	MIN	NOM	MAX
A			1.20
A1	0.05		0.15
A2	0.80		1.05
b	0.19		0.30
c	0.09		0.20
D	6.40	6.50	6.60
E	6.30	6.40	6.50
E1	4.30	4.40	4.50
e		0.65 BSC	
L	0.45	0.60	0.75
L1		1.00 REF	
θ	0°		8°



SIDE VIEW



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